LEOCO CORPORATION	PRODUCTION SPECIFICATION	No.	S-98-7605-3

* P.C.B.Ganged Jack Series Connector *

This product specification contains the test method ,the general performance and requirements for Leoco 7604 and 7605 series PCB ganged jack system.

- 1. Construction and dimensions shall be in accordance with the referenced drawings.
- 2. Characteristics 特性;

Current rating 额定电流: 1.5 A AC/DC Voltage rating 额定电压: 125 v AC/DC,

Temperature rating 额定温度:-25° C----+105° C

3. Electrical performance 电气性能:								
Item 项目	Description 内容	Test Method & Condition 测试方法及条件	Requirement 需求					
3.1	Contact Resistance 接触阻抗	It should be tested in accordance with method 3004.1 of MIL-STD-1344A	20 mΩ max					
3.2	Insulation Resistance 绝缘阻抗	It should be tested in accordance with method 3003.1 of MIL-STD-1344A	1000 mΩ min					
3.3	Dielectric withstanding voltage 耐电压	Unmated connector shall be tested in accordance with method 3001.1 of MIL-STD-1344A When the AC 500 V rms for one minute applied between adjacent contacts.	No evidence of breakdown and flashover					
4. Mechanical Performance 机械性能:								
Item 项目	Description 内容	Test Method & Condition 测试方法及条件	Requirement 需求					
4.1	Insertion force 插入力		2-Contacts—350 gram 4-Contacts—500 gram 6-Contacts—750 gram 8-Contacts—900 gram (max)					

需求
ne plug at 2-Contacts—350 gram 4-Contacts—500 gram 6-Contacts—750 gram
8-Contacts—900 gram (max) lephone 7.7 kgf min
ce with No defects. A. Contact resistance shall be to 100 20 MΩ max wal.

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5. Environmental Performance 环境性能:								
Item 项目	Description 内容		Test Method & Condition 测试方法及条件	Requirement 需求				
5.1	Humidity 耐湿性	in ac MIL- cond Tem Hum	unmated connector shall be tested cordance with method 1002.2 of STD-1344A test procedure type I lition B. perature: 40±2°C idity:90—95% (RH) od: 96 hours	No damage. Contact resistance Less than twice of initial. Insulation resistance:to pass parameter.3-2 Dielectric withstanding voltage: to pass parameter 3-3				
5.2	Salt spray 盐雾测试	with cond Tem Dens	nector shall be tested in accordance method 1001.1 of MIL-STD-1344A lition B. perature: 35±2°C sity: 5% in weight. od: 48 hours.	No damage. Contact resistance less than twice of initial.				
5.3	Solderability 着锡性	chec with Sold	nector termination ends shall be ked for solderability in accordance method 208 of MIL-STD-202F. er temperature : 245±5°C ersion period :5±0.5 sec.		_	e. 95% of immersed		
5.4	Resistance to soldering heat 耐高温测试	Sold	cimen shall be mounted on PCB. er temperature : 260±5℃ ersion period :5±0.5 sec.	No c	damag	e and information		
APPR I			HKD BY :		C BY			